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BGA stencil for Samsung Galaxy S4 (i9505)

Product ID: 21744

Price: **6.20 EUR**

Product weight: **0.02 kg**

Description:

BGA stencil for Samsung Galaxy S4 (i9505) plating kit it's a BGA stencil matrix needed when you have to exchange BGA parts of your phone and wan't to apply BGA balls into IC.

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